

Engineering/Process Change Notice

ECN/PCN No.: 4120

For Manufacturer							
Product Description: PLASTIC SMD MEMS OSCILLATOR	Abracon Part Number / Part Series: □ Documentat EMK11 □ ECN ⊠ EOL			☑ Series □ Part Number			
Affected Revision: N	New Revision: EC	Application:	□ Safety ⊠ Non-Safety				
Prior to Change: Active https://abracon.com/datasheets/Ecliptek/	EMK11.pdf						
After Change: EOL							
Cause/Reason for Change: Discontinuation of manufacturing capabilit	Ξ y .						
	Chan	ge Plan					
Effective Date: 2/7/2022	Additional Remarks: N/A						
Change Declaration: N/A	•						
Issued Date: 2/7/2022	Issued By: Brooke Cushman Product Engineer		Issued Department: Engineering				
Approval: Thomas Culhane Engineering Director	Approval: Reuben Qu Quality [Approval: Ying Huang Purchasing Director				
	For Abrac	on EOL only					
Last Time Buy (if applicable): 5/7/2022	able): Alternate Part Number / Part Series:						
Additional Approval:	Additional Approval:		Additional Approval:				
	Customer Appro	val (If Applicable)					
Qualification Status:							
Customer Part Number:		Customer Project:					
Company Name:	Company Representative:		Representative Signature	:			
Customer Remarks:							

Form #7020 | Rev. G | Effective: 02/22/2021 |

Page **1** of **1**



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R	REGULATORY COMPLIANCE					
	Lead Free	EU RoHS		China RoHS		REACH
	Po	2011/65 + 2015/863		e		SVHC
	COMPLIANT	COMPLIANT		COMPLIANT		COMPLIANT



ITEM DESCRIPTION

MEMS Clock Oscillators LVCMOS (CMOS) 1.8Vdc 4 Pad 5.0mm x 7.0mm Plastic Surface Mount (SMD)

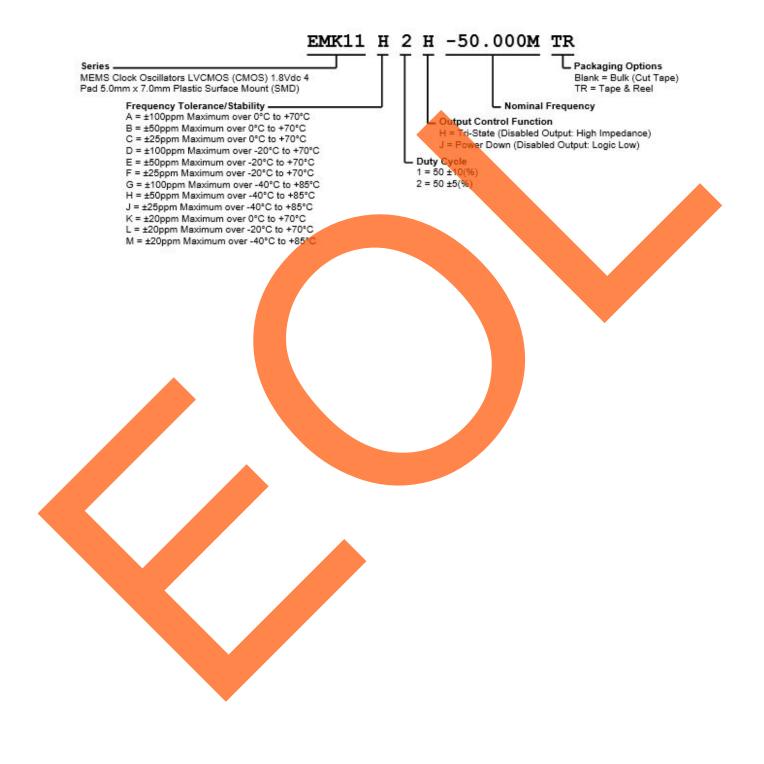
ELECTRICAL SPECIFICAT	IONS
Nominal Frequency	1MHz to 125MHz
Frequency Tolerance/Stability	Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Supply Voltage Change, and Output Load Change ±100ppm Maximum over 0°C to +70°C ±50ppm Maximum over 0°C to +70°C ±25ppm Maximum over 0°C to +70°C ±20ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C ±25ppm Maximum over -20°C to +70°C ±25ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +85°C ±20ppm Maximum over -40°C to +85°C ±50ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C
Aging at 25°C	±1.5ppm Max <mark>imum F</mark> irst Year
Supply Voltage	1.8Vdc ±10%
Input Current	No Load 4.5mA Maximum over Nominal Frequency of 1MHz to 20MHz 5mA Maximum over Nominal Frequency of 20.000001MHz to 50MHz 6mA Maximum over Nominal Frequency of 50.000001MHz to 80MHz 7mA Maximum over Nominal Frequency of 80.000001MHz to 125MHz
Output Voltage Logic High (V _{oh})	IOH = -2mA 90% of Vdd Minimum
Output Voltage Logic Low (Vol)	IOL = +2mA 10% of Vdd Maximum
Rise/Fall Time	Measured from 20% to 80% of waveform 1.5 <mark>pSec Typical</mark> , 3.5nSec Maximum
Duty Cycle	Measured at 50% of waveform 50 ±10(%) 50 ±5(%)
Load Drive Capability	15pF Maximum
Output Logic Type	CMOS
Output Control Function	Tri-State (Disabled Output: High Impedance) Power Down (Disabled Output: Logic Low)
Output Control Input Voltage Logic High (Vih)	70% of Vdd Minimum or No Connect to Enable Output
Output Control Input Voltage Logic	30% of Vdd Maximum to Disable Output
Power Down Output Enable Time	5mSec Maximum
Tri-State Output Enable Time	150nSec Maximum
Power Down Output Disable Time	150nSec Maximum
Tri-State Output Disable Time	150nSec Maximum
Standby Current	5µA Maximum (Disabled Output: Logic Low)
Period Jitter (RMS)	2pSec Typical, 5pSec Maximum
RMS Phase Jitter (Fj = 900kHz to 7.5MHz; Random)	0.5pSec Typical, 1pSec Maximum



RMS Phase Jitter (Fj = 12kHz to 20MHz; Random)	1.5pSec Typical, 3pSec Maximum
Start Up Time	5mSec Maximum
Storage Temperature Range	-65°C to +150°C

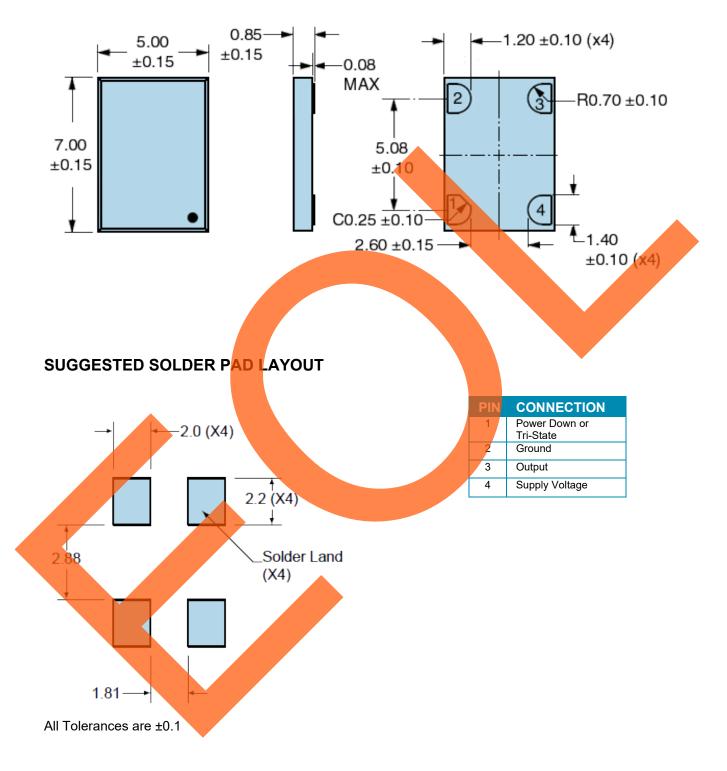


PART NUMBERING GUIDE





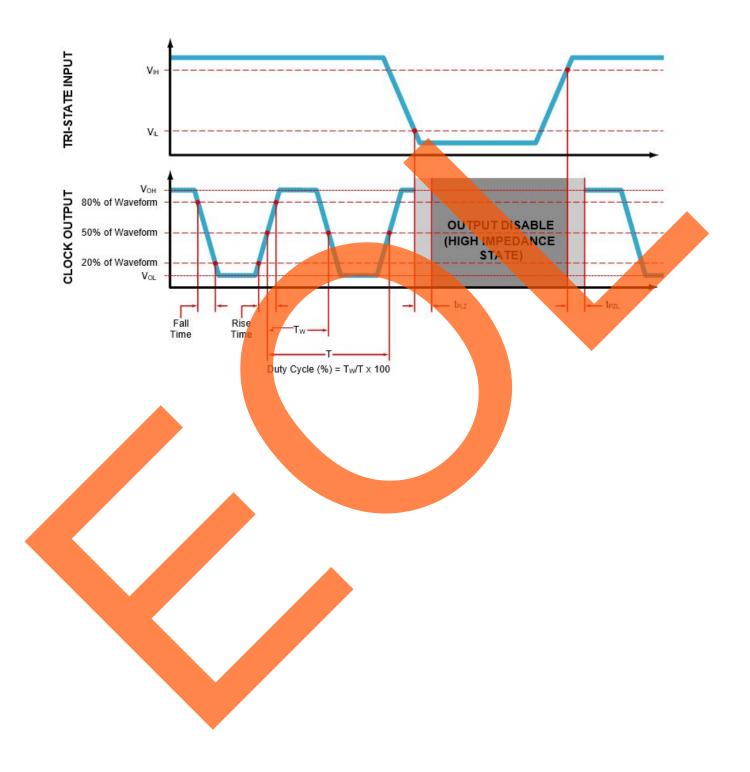
MECHANICAL DIMENSIONS



All Dimensions in Millimeters

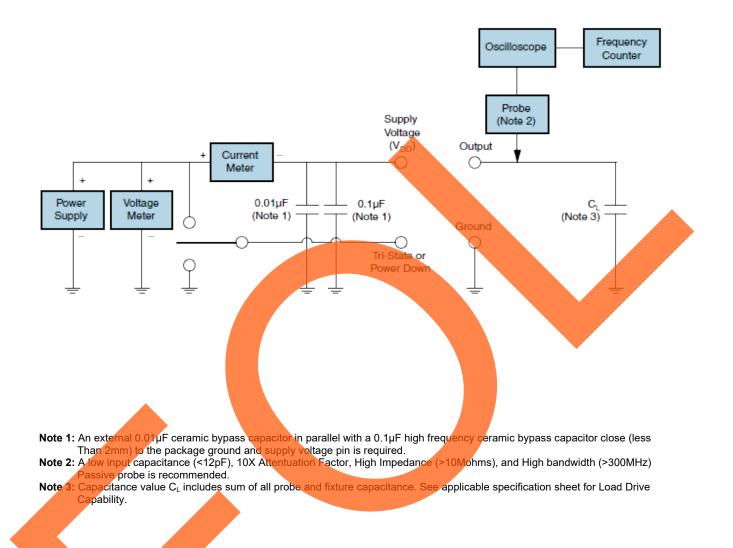


OUTPUT WAVEFORM & TIMING DIAGRAM





TEST CIRCUIT FOR CMOS OUTPUT



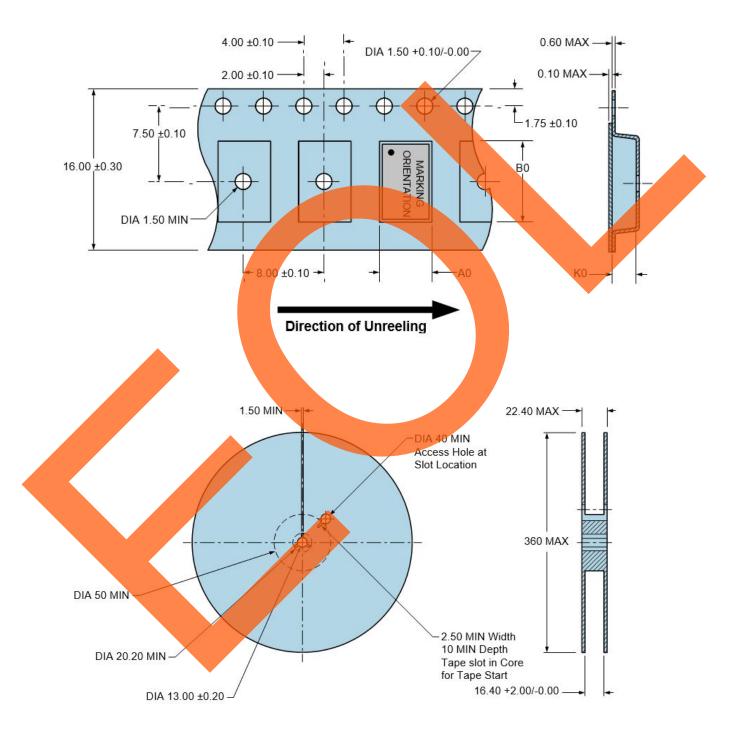


TAPE & REEL DIMENSIONS

Quantity per Reel: 1,000 Units

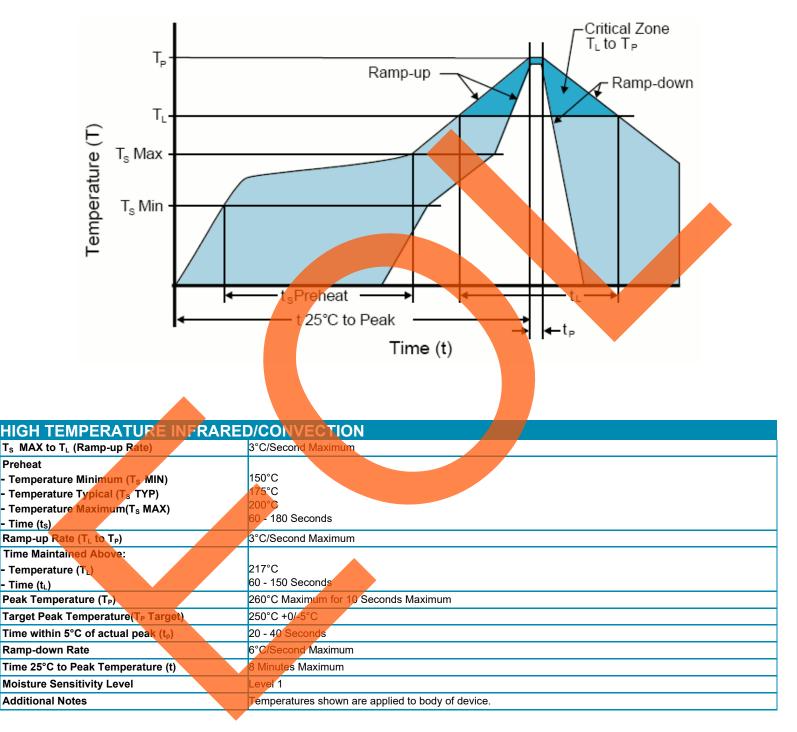
All Dimensions in Millimeters

Compliant to EIA-481





RECOMMENDED SOLDER REFLOW METHOD

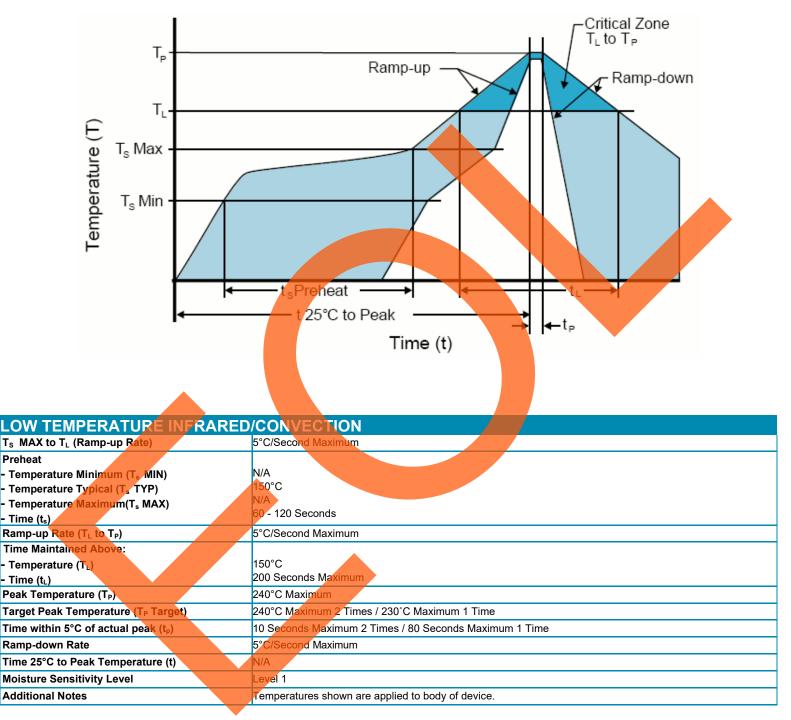


High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



RECOMMENDED SOLDER REFLOW METHOD



Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)